Sheet 1 of 1...

Form 1449\*

Atty. Docket No.: 884.424US1

Serial No. Unknown

Applicant: Jonathan McFarland et al.

Group: Unknown

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use several sheets if necessary)

U.S. PATENT DOCUMENTS

Filing Date: Herewith

**Rxaminer Initial	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
<u>Λ 1/</u>						
Hulla	2 5,136,359	08/04/1992	Takayama, Y., et al.	357	65	12/19/90
	_ 5,188,702	02/23/1993	Takayama, Y., et al.	156	630	04/23/92
	_ 5,262,226	11/16/1993	Yoshida, Y.	428	209	03/04/91
	_ 5,502,891	04/02/1996	Mori, H., et al.	29	840	07/05/94
	_ 5,604,379	02/18/1997	Mori, K., et al.	257	738	05/30/95
	_ 5,679,493	10/21/1997	Kai, T.	430	126	10/02/95
	_ 5,681,647	10/28/1997	Caillat, P.	428	209	10/03/95
	_ 5,770,305	06/23/1998	Terasaka, S.	428	328	09/27/95
	_ 5,879,530	03/09/1999	Caillat, P.	205	122	05/29/97
<u> </u>	_ 6,031,590	02/29/2000	Kim, S.J.	349	86	01/21/98
			÷			
		FO	REIGN PATENT DOCUMENTS			
**Examiner						Translation

**Examiner						Translation	
Initial	Document Number	Date	Country	Class	Subclass	Yes No	
******		2400	oomer,	V-455	•		

## OTHER DOCUMENTS

(Including Author, Title, Date, Pertinent Pages, Etc.)

"Flip Chip Assembly Utilizing Anisotropic Conductive Delaney, D., et al., Films: A Feasibility Study", 2000 Electronic Components and Technology Conference, 641-645, (2000)

Examiner

Date Considered